

## C0603C201JAGAC7411

SMD Comm COG, Ceramic, 200 pF, 5%, 250 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0603, 0.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	3.7 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		Sp
Chip Size	0603	Ca
L	1.6mm +/-0.15mm	Me
W	0.8mm +/-0.15mm	Tol
т	0.8mm +/-0.07mm	Vol
S	0.5mm MIN	Die
В	0.35mm +/-0.15mm	Ter
		Ter

## **Packaging Specifications** T&R, 330mm, Paper Tape Packaging Packaging Quantity 15000

Specifications	
Capacitance	200 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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